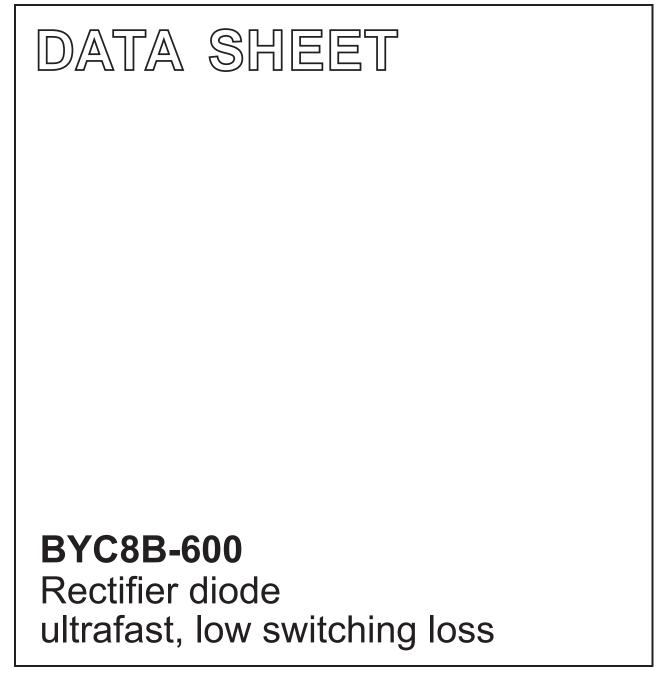
DISCRETE SEMICONDUCTORS



Product specification

March 2001



BYC8B-600

FEATURES

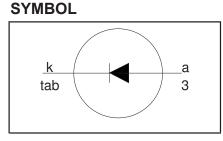
- Extremely fast switching
- Low reverse recovery current
- Low thermal resistance
- Reduces switching losses in associated MOSFET

APPLICATIONS

- Active power factor correction
- Half-bridge lighting ballastsHalf-bridge/ full-bridge switched

mode power supplies.

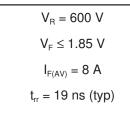
The BYC8B-600 is supplied in the SOT404 surface mounting package.



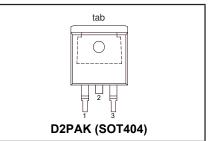
PINNING

DESCRIPTION		
no connection		
cathode ¹		
anode		
cathode		

QUICK REFERENCE DATA



SOT404



LIMITING VALUES

Limiting values in accordance with the Absolute Maximum System (IEC 134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V _{RRM}	Peak repetitive reverse voltage		-	600	V
V _{RWM}	Crest working reverse voltage		-	600	V
V _R	Continuous reverse voltage	$T_{mb} \leq 110 \degree C$	-	500	V
I _{F(AV)}	Average forward current	$\delta = 0.5$; with reapplied V _{RRM(max)} ;	-	8	A
I _{FRM}	Repetitive peak forward current	$ \begin{array}{l} T_{mb} \leq 82 \ ^{\circ}C \\ \delta = 0.5; \mbox{ with reapplied } V_{RRM(max)}; \\ T_{mb} \leq 82 \ ^{\circ}C \end{array} $	-	16	A
I _{FSM}	Non-repetitive peak forward	t = 10 ms	-	55	A
	current.	t = 8.3 ms sinusoidal; T _i = 150°C prior to surge	-	60	A
_		with reapplied V _{RWM(max)}		. – .	
<u>T</u> _{stg}	Storage temperature		-40	150	°C
T _i	Operating junction temperature		-	150	O°

THERMAL RESISTANCES

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
R _{th j-mb}	Thermal resistance junction to		-	-	2.2	K/W
R _{th j-a}	mounting base Thermal resistance junction to ambient	minimum footprint, FR4 board	-	50	-	K/W

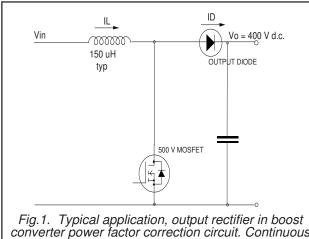
¹ it is not possible to make connection to pin 2 of the SOT404 package

BYC8B-600

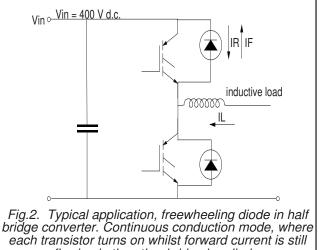
ELECTRICAL CHARACTERISTICS

 $T_i = 25$ °C unless otherwise stated

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
V _F	Forward voltage	I _F = 8 A; Τ _i = 150°C	-	1.4	1.85	V
		$I_{F} = 16 \text{ Å}; T_{j} = 150^{\circ}\text{C}$	-	1.7	2.3	V
1_	Reverse current	I _F = 8 A; V _B = 600 V	-	2.0 9	2.9 150	ν μA
I _R		$V_{R} = 500 V; T_{j} = 100 °C$	-	1.1	3.0	mΑ
t _{rr}	Reverse recovery time	$I_{\rm F} = 1 \text{ A}; V_{\rm B} = 30 \text{ V}; dI_{\rm F}/dt = 50 \text{ A}/\mu\text{s}$	-	30	52	ns
t _{rr}	Reverse recovery time	$I_{\rm F} = 8 \text{ A}; V_{\rm R} = 400 \text{ V};$	-	19	-	ns
t _{rr}	Reverse recovery time	dI _F /dt = 500 A/µs I _F = 8 A; V _R = 400 V; dI _F /dt = 500 A/µs; T _j = 100°C	-	32	40	ns
I _{rrm}	Peak reverse recovery current	I _F = 8 A; V _R = 400 V; dI _F /dt = 50 A/μs; T _i = 125°C	-	1.5	5.5	А
l _{rrm}	Peak reverse recovery current	$dI_{F}/dt = 50 A/\mu s, T_{j} = 125 C$ $I_{F} = 8 A; V_{R} = 400 V;$ $dI_{F}/dt = 500 A/\mu s; T_{j} = 125 °C$	-	9.5	12	А
V _{fr}	Forward recovery voltage	$I_F = 10 \text{ A}; dI_F/dt = 100 \text{ A}/\mu\text{s}$	-	8	10	V

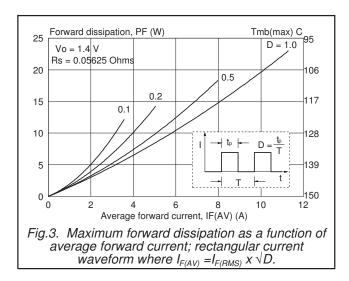


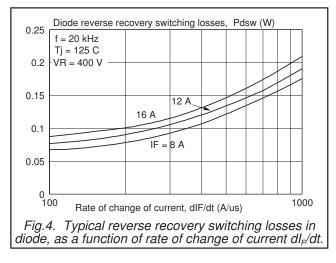
converter power factor correction circuit. Continuous conduction, mode where the transistor turns on whilst forward current is still flowing in the diode.

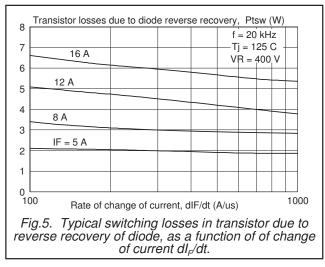


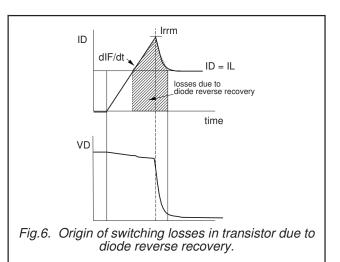
flowing in the other bridge leg diode.

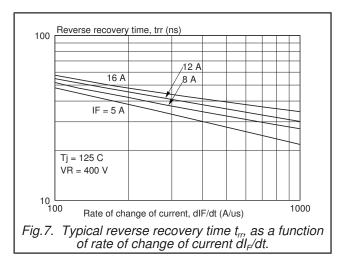
BYC8B-600

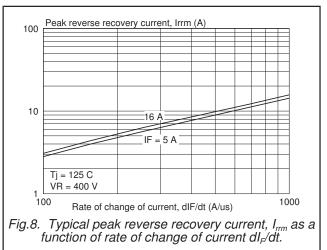




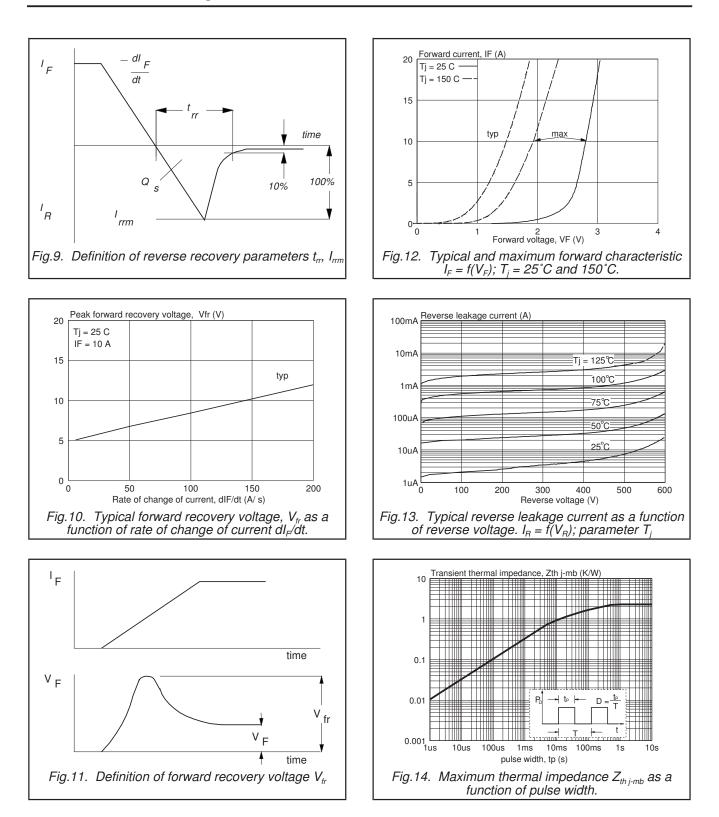






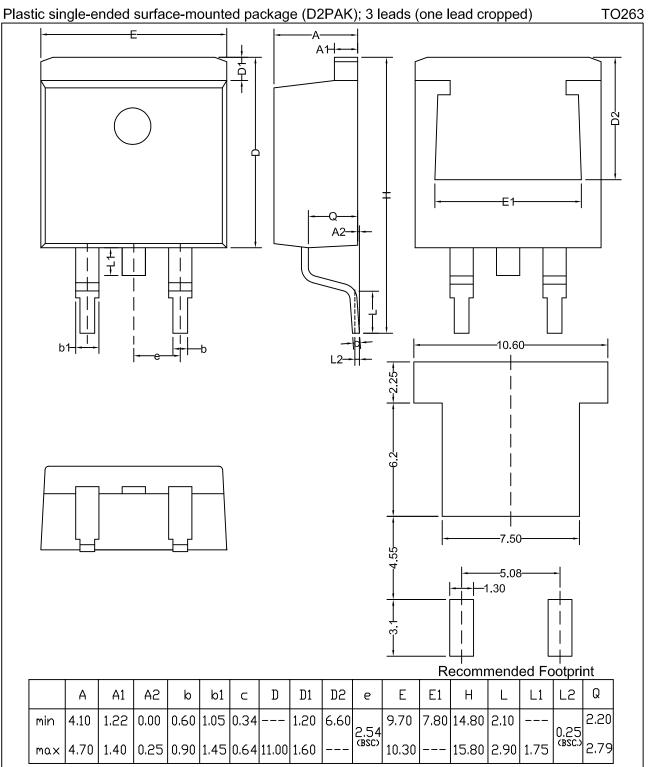


BYC8B-600



BYC8B-600

MECHANICAL DATA



Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions".
- [3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL <u>http://www.ween-semi.com</u>.

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